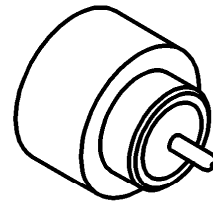
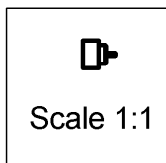
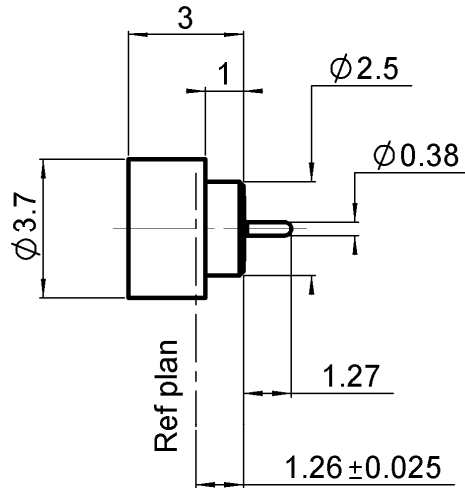


HERMETIC STRAIGHT MALE RECEPTACLE

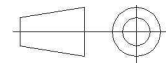
SOLDER TYPE - FULL DETENT

R222.645.020

Series : SMP



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)
BODY	DILVER P1	GOLD 0.5 OVER NICKEL 2
CENTER CONTACT	DILVER P1	GOLD 0.5 OVER NICKEL 2
OUTER CONTACT		
INSULATOR	GLASS	
GASKET		
OTHERS PARTS		
-	-	-
-	-	-

Issue : 0951 B

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



HERMETIC STRAIGHT MALE RECEPTACLE**R222.645.020****SOLDER TYPE - FULL DETENT**

Series : SMP

PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION**ELECTRICAL CHARACTERISTICS**

Impedance	50	Ω
Frequency	0-18	GHz
VSWR	1.15 + 0,0000	x F(GHz) Maxi
Insertion loss	0.12	$\sqrt{F}(\text{GHz})$ dB Maxi
RF leakage	- (	- F(GHz)) dB Maxi
Voltage rating	335	Veff Maxi
Dielectric withstanding voltage	500	Veff mini
Insulation resistance	5000	M Ω mini

ENVIRONMENTAL

Operating temperature	-65/+165	$^{\circ}\text{C}$
Hermetic seal	10-8	Atm.cm ³ /s
Panel leakage		

OTHERS CHARACTERISTICS

Assembly instruction

Others :

MECHANICAL CHARACTERISTICS

Center contact retention		
Axial force – Mating end	6.8	N mini
Axial force – Opposite end	6.8	N mini
Torque		N.cm mini
Recommended torque		
Mating		N.cm
Panel nut		N.cm
Mating life	100	Cycles mini
Weight	0,0800	g

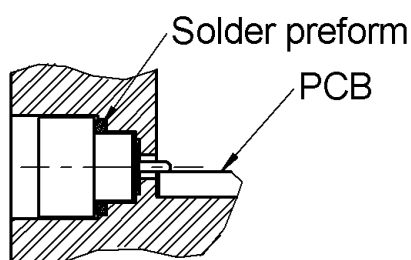
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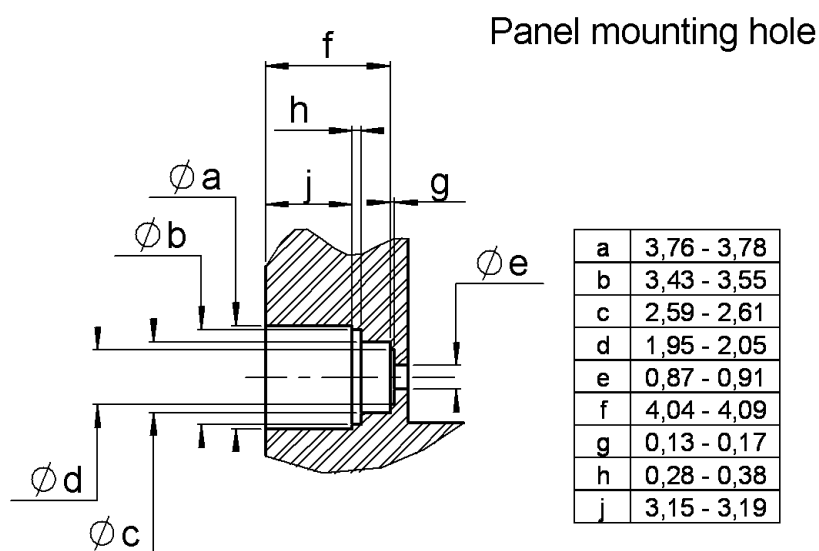


HERMETIC STRAIGHT MALE RECEPTACLE**R222.645.020****SOLDER TYPE - FULL DETENT**

Series : SMP



1. Degrease and clean connector and box
2. Solder the connector on the panel
we advise SnAg4 Cu0.5, we recommend a low residue flux.
Preheating at 100 °C. Take care not to exceed 260°C during solder operation
3. Solder the pin on the track
we advise SnAg4 Cu0.5, we recommend a low residue flux.
Preheating at 100 °C (only for ceramic substrate). Take care not to exceed 260°C during solder operation



Issue : 0951 B

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